

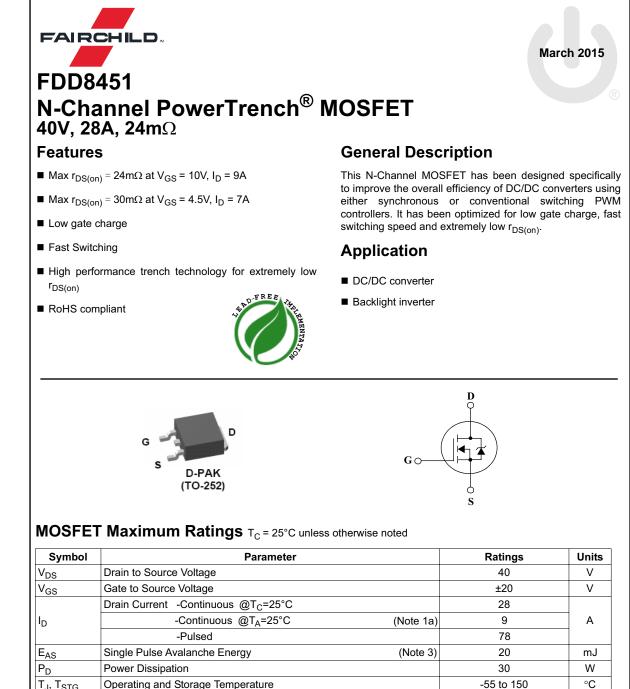
Is Now Part of



# **ON Semiconductor**®

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**Device Marking** 

FDD8451

Thermal Characteristics

Thermal Resistance, Junction to Case

Thermal Resistance, Junction to Ambient

Thermal Resistance, Junction to Ambient

Package Marking and Ordering Information

Device

FDD8451

T<sub>J</sub>, T<sub>STG</sub>

 $R_{\theta JC}$ 

 $R_{\theta,IA}$ 

 $R_{\theta JA}$ 

Package

D-PAK(TO-252)

Quantity

2500 units

°C

°C/W

°C/W

°C/W

4.1 40

96

Tape Width

16mm

(Note 1a)

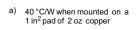
(Note 1b)

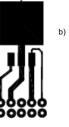
**Reel Size** 

13"

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, referenced to 25°C		33.5		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 32V, V <sub>GS</sub> = 0V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
On Chara	icteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA	1	2.1	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu$ A, referenced to $25^{\circ}$ C		-5.7		mV/°C
r <sub>DS(on)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 9A		19	24	mΩ
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 7A		23	30	
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 9A T <sub>J</sub> = 150°C		32	41	
9 <sub>FS</sub>	Forward Transcondductance	V <sub>DS</sub> = 5V, I <sub>D</sub> = 9A		29		S
Dynamic C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$		780 112	990 150	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		72	110	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		1.1		Ω
Oitakin.	g Characteristics					
	-			7	14	ns
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 9A		7	14 10	ns ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	$V_{DD}$ = 20V, I <sub>D</sub> = 9A $V_{GS}$ = 10V, R <sub>GEN</sub> = 6 $\Omega$		7 3 19	14 10 34	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time			3	10	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time       Rise Time       Turn-Off Delay Time			3 19	10 34	ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time			3 19 2	10 34 10	ns ns ns
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \\ Q_{g} \end{array}$	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V	V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		3 19 2 16	10 34 10 20	ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6	10 34 10 20	ns ns ns nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-So	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate Charge at 10VTotal Gate Charge at 5VGate to Source Gate ChargeGate to Drain "Miller"Charge	$V_{GS} = 10V, R_{GEN} = 6Ω$ $V_{DS} = 20V, I_D = 9A$ $V_{GS} = 10V$ e $V_{GS} = 0V, I_S = 9A$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge at 10V         Total Gate Charge at 5V         Gate to Source Gate Charge         Gate to Drain "Miller"Charge         urce Diode Characteristics	$V_{GS}^{-}$ = 10V, $R_{GEN}$ = 6Ω $V_{DS}$ = 20V, $I_{D}$ = 9A $V_{GS}$ = 10V		3 19 2 16 8.6 2.5 3.7	10 34 10 20 11	ns ns nC nC nC nC

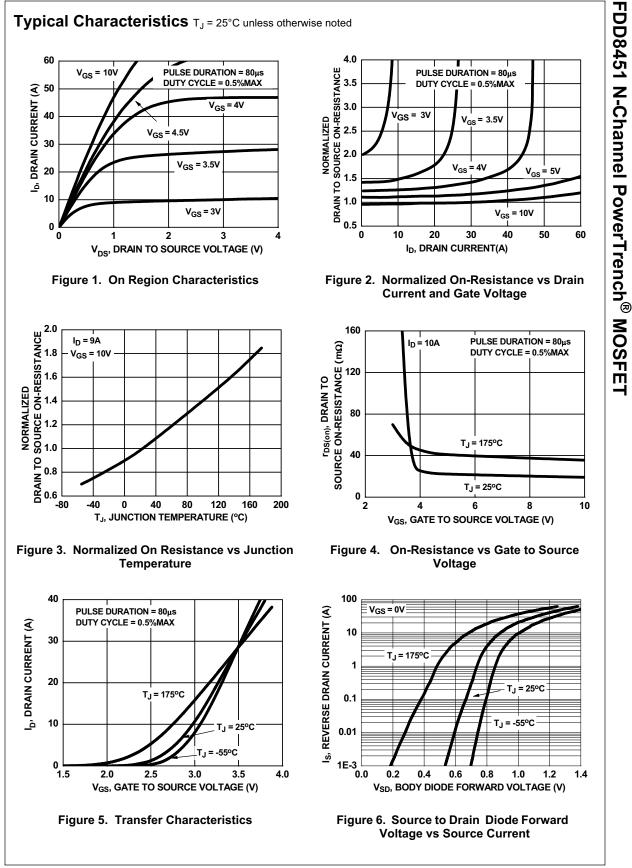




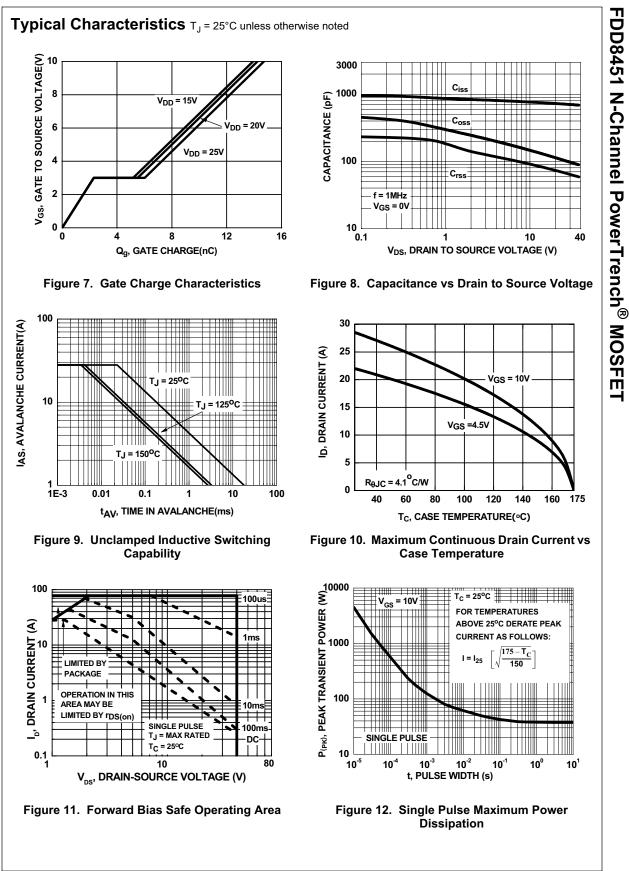


96 °C/W when mounted on a minimum pad

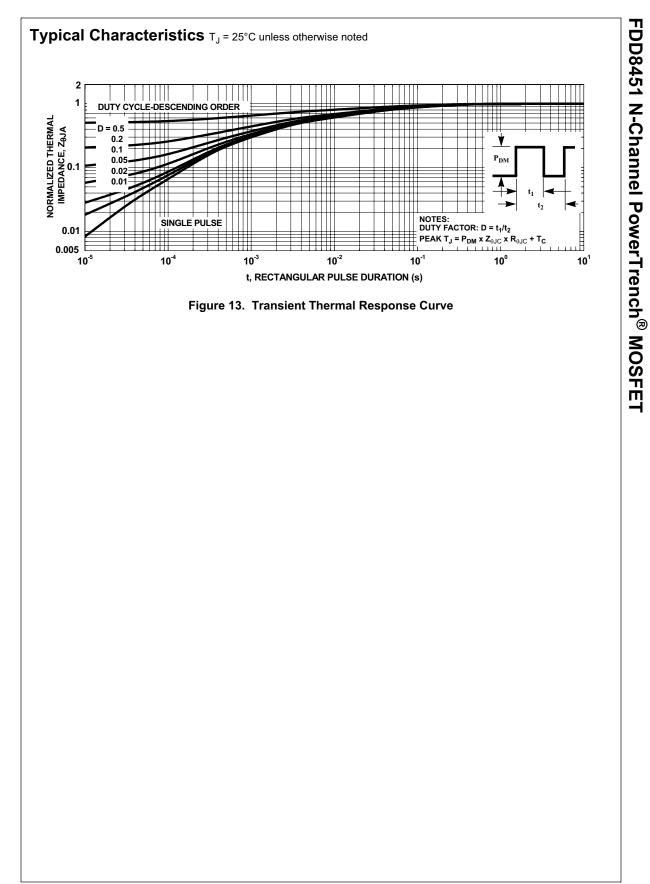
FDD8451 N-Channel PowerTrench<sup>®</sup> MOSFET

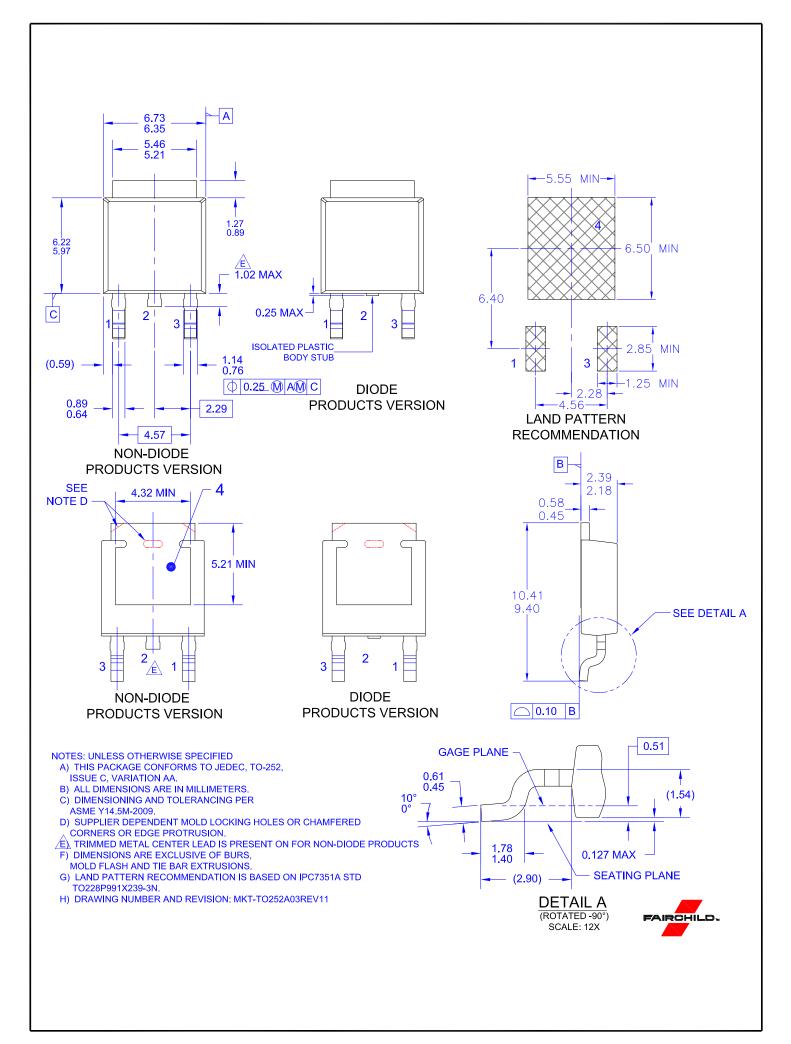


FDD8451 Rev. 1.2



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